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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	M32C/80
Core Size	16/32-Bit
Speed	32MHz
Connectivity	CANbus, EBI/EMI, I ² C, IEBus, IrDA, SIO, UART/USART
Peripherals	DMA, POR, PWM, WDT
Number of I/O	121
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	48K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 34x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m3087bflagp-u5

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1. Overview

1.1 Features

The M32C/87 Group (M32C/87, M32C/87A, M32C/87B) is a single-chip control MCU, fabricated using high-performance silicon gate CMOS technology, embedding the M32C/80 Series CPU core. The M32C/87 Group (M32C/87, M32C/87A, M32C/87B) is housed in 144-pin and 100-pin plastic molded LQFP/QFP packages.

With a 16-Mbyte address space, this MCU combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed.

The M32C/87 Group (M32C/87, M32C/87A, M32C/87B) has a multiplier and DMAC adequate for office automation, communication devices and industrial equipment, and other high-speed processing applications.

1.1.1 Applications

Audio components, cameras, office equipment, communication devices, mobile devices, etc.

1.2 Product List

Tables 1.5 to 1.7 list product information. Figure 1.1 shows product numbering system.

Table 1.5 M32C/87 Group (1) (M32C/87: 2-channel CAN module) Current as of Jul. 2008

Part Number	Package Code	ROM Capacity	RAM Capacity	Remarks
M3087BFLGP	PLQP0144KA-A (144P6Q-A)	1 MB + 4 KB ⁽¹⁾	48 KB	Flash memory
M30879FLFP	PRQP0100JB-A (100P6S-A)			
M30879FLGP	PLQP0100KB-A (100P6Q-A)			
M3087BFGKP	PLQP0144KA-A (144P6Q-A)	768 KB + 4 KB ⁽¹⁾		
M30879FKGP	PLQP0100KB-A (100P6Q-A)			
M30878FJGP	PLQP0144KA-A (144P6Q-A)	512 KB + 4 KB ⁽¹⁾	31 KB	
M30876FJGP	PLQP0100KB-A (100P6Q-A)			
M30875FHGP	PLQP0144KA-A (144P6Q-A)	384 KB + 4 KB ⁽¹⁾	24 KB	
M30873FHGP	PLQP0100KB-A (100P6Q-A)			
M30878MJ-XXXGP	PLQP0144KA-A (144P6Q-A)	512 KB	31 KB	Mask ROM
M30876MJ-XXXFP	PRQP0100JB-A (100P6S-A)			
M30876MJ-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30875MH-XXXGP	PLQP0144KA-A (144P6Q-A)	384 KB	24 KB	
M30873MH-XXXGP	PLQP0100KB-A (100P6Q-A)			

NOTE:

1. Additional 4-Kbyte space is available for data flash memory.

Table 1.6 M32C/87 Group (2) (M32C/87A: 1-channel CAN module) Current as of Jul. 2008

Part Number	Package Code	ROM Capacity	RAM Capacity	Remarks
M3087BFLAGP	PLQP0144KA-A (144P6Q-A)	1 MB + 4 KB ⁽¹⁾	48 KB	Flash memory
M30879FLAFP	PRQP0100JB-A (100P6S-A)			
M30879FLAGP	PLQP0100KB-A (100P6Q-A)			
M3087BFKAGP	PLQP0144KA-A (144P6Q-A)	768 KB + 4 KB ⁽¹⁾		
M30879FKAGP	PLQP0100KB-A (100P6Q-A)			
M30878FJAGP	PLQP0144KA-A (144P6Q-A)	512 KB + 4 KB ⁽¹⁾	31 KB	
M30876FJAGP	PLQP0100KB-A (100P6Q-A)			
M30875FHAGP	PLQP0144KA-A (144P6Q-A)	384 KB + 4 KB ⁽¹⁾	24 KB	
M30873FHAGP	PLQP0100KB-A (100P6Q-A)			
M30878MJA-XXXGP	PLQP0144KA-A (144P6Q-A)	512 KB	31 KB	Mask ROM
M30876MJA-XXXFP	PRQP0100JB-A (100P6S-A)			
M30876MJA-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30875MHA-XXXGP	PLQP0144KA-A (144P6Q-A)	384 KB	24 KB	
M30873MHA-XXXGP	PLQP0100KB-A (100P6Q-A)			

NOTE:

1. Additional 4-Kbyte space is available for data flash memory.

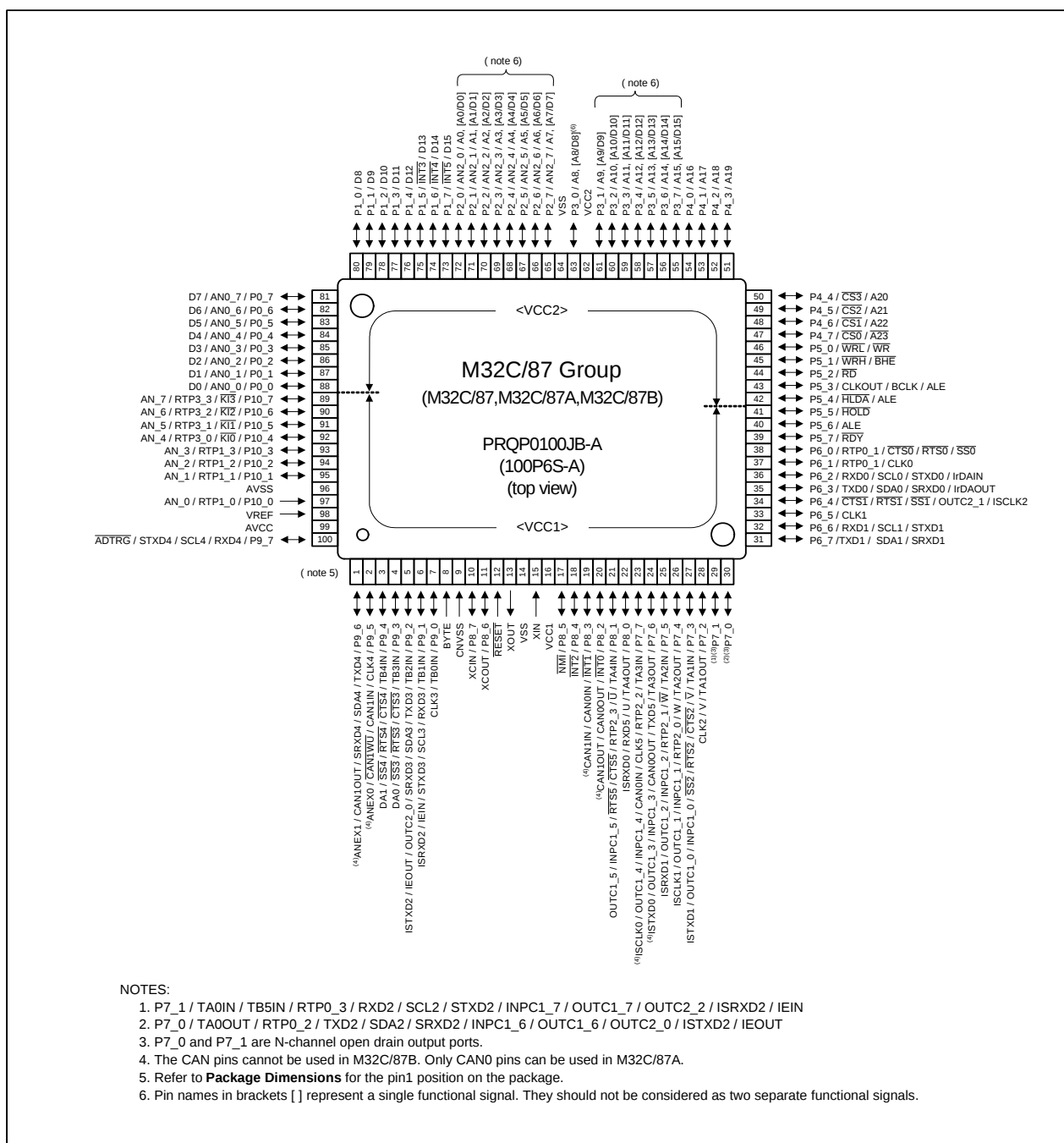


Figure 1.4 Pin Assignment for 100-Pin Package

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers.

The register bank is comprised of eight registers (R0, R1, R2, R3, A0, A1, SB, and FB) out of 28 CPU registers. There are two sets of register banks.

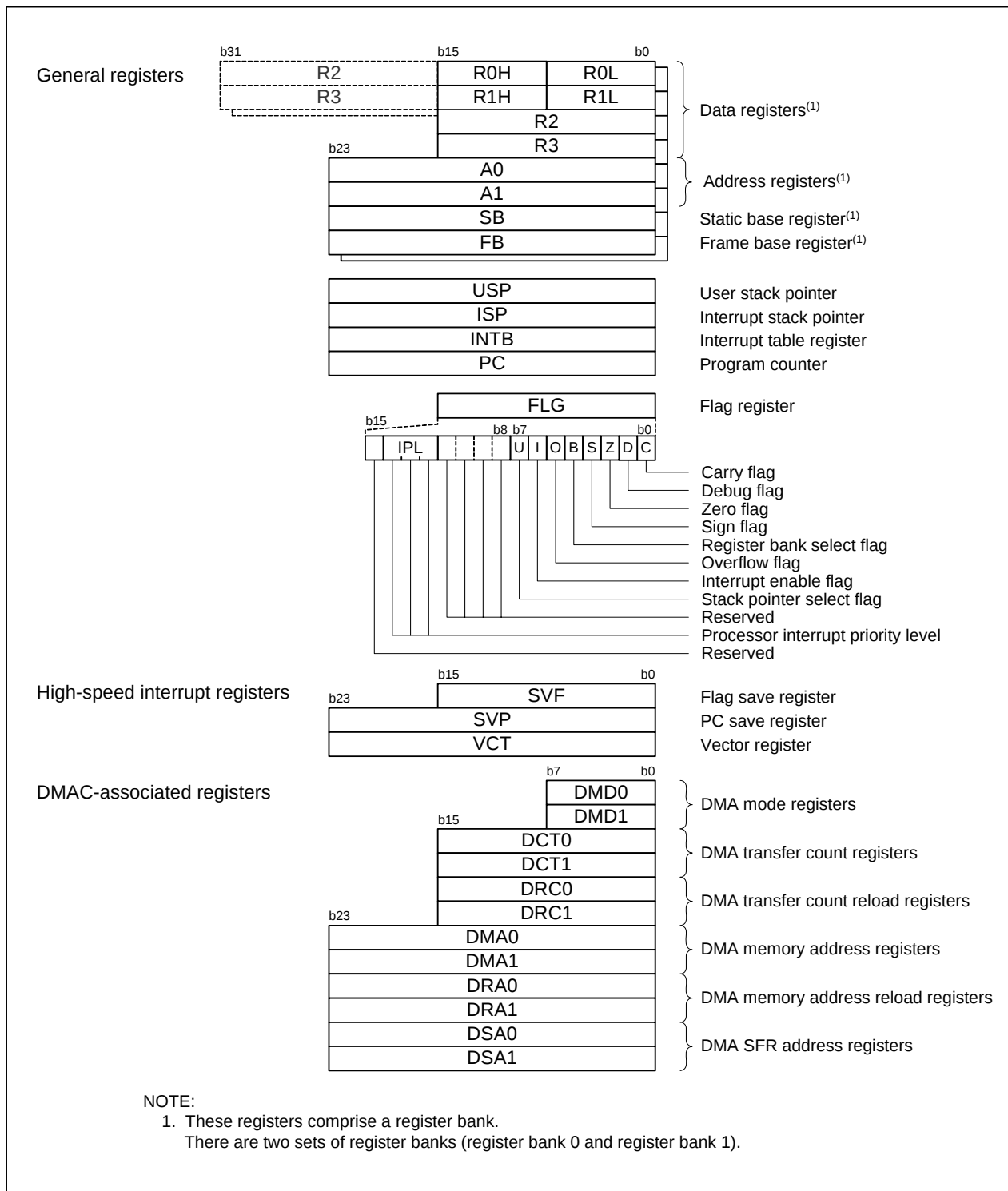


Figure 2.1 CPU Register

2.1 General Registers

2.1.1 Data Registers (R0, R1, R2, and R3)

R0, R1, R2, and R3 are 16-bit registers for transfer, arithmetic and logic operations. R0 and R1 can be split into high-order (R0H/R1H) and low-order bits (R0L/R1L) to be used separately as 8-bit data registers. R0 can be combined with R2 and used as a 32-bit data register (R2R0). The same applies to R3R1.

2.1.2 Address Registers (A0 and A1)

A0 and A1 are 24-bit registers used for A0-/A1-indirect addressing, A0-/A1-relative addressing, transfer, arithmetic and logic operations.

2.1.3 Static Base Register (SB)

SB is a 24-bit register used for SB-relative addressing.

2.1.4 Frame Base Register (FB)

FB is a 24-bit register used for FB-relative addressing.

2.1.5 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are 24 bits wide each. The U flag is used to switch between USP and ISP. Refer to **2.1.8 Flag Register (FLG)** for details on the U flag. Set USP and ISP to even addresses to execute an interrupt sequence efficiently.

2.1.6 Interrupt Table Register (INTB)

INTB is a 24-bit register indicating the starting address of a relocatable interrupt vector table.

2.1.7 Program Counter (PC)

PC is 24 bits wide and indicates the address of the next instruction to be executed.

2.1.8 Flag Register (FLG)

FLG is a 16-bit register indicating the CPU state.

2.1.8.1 Carry Flag (C)

The C flag indicates whether or not carry or borrow has been generated after executing an instruction.

2.1.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.1.8.3 Zero Flag (Z)

The Z flag becomes 1 when an arithmetic operation results in 0; otherwise becomes 0.

2.1.8.4 Sign Flag (S)

The S flag becomes 1 when an arithmetic operation results in a negative value; otherwise becomes 0.

2.1.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is set to 0. Register bank 1 is selected when this flag is set to 1.

2.1.8.6 Overflow Flag (O)

The O flag becomes 1 when an arithmetic operation results in an overflow; otherwise becomes 0.

2.1.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0 and enabled when it is set to 1. The I flag becomes 0 when an interrupt request is acknowledged.

2.1.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0. USP is selected when the U flag is set to 1.

The U flag becomes 0 when a hardware interrupt request is acknowledged or the INT instruction specifying software interrupt numbers 0 to 31 is executed.

2.1.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has higher priority level than IPL, the interrupt is enabled.

2.1.8.10 Reserved Space

Only write 0 to bits assigned to the reserved space. When read, the bits return undefined values.

2.2 High-Speed Interrupt Registers

Registers associated with the high-speed interrupt are as follows:

- Flag save register (SVF)
- PC save register (SVP)
- Vector register (VCT)

2.3 DMAC-Associated Registers

Registers associated with the DMAC are as follows:

- DMA mode register (DMD0, DMD1)
- DMA transfer count register (DCT0, DCT1)
- DMA transfer count reload register (DRC0, DRC1)
- DMA memory address register (DMA0, DMA1)
- DMA memory address reload register (DRA0, DRA1)
- DMA SFR address register (DSA0, DSA1)

Table 4.8 SFR Address Map (8/20)

Address	Register	Symbol	After Reset
01C0h	UART5 Transmit/Receive Mode Register	U5MR	00h
01C1h	UART5 Baud Rate Register	U5BRG	XXh
01C2h	UART5 Transmit Buffer Register	U5TB	XXXXh
01C3h			
01C4h	UART5 Transmit/Receive Control Register 0	U5C0	0000 1000b
01C5h	UART5 Transmit/Receive Control Register 1	U5C1	XXXX 0010b
01C6h	UART5 Receive Buffer Register	U5RB	XXXXh
01C7h			
01C8h	UART6 Transmit/Receive Mode Register	U6MR	00h
01C9h	UART6 Baud Rate Register	U6BRG	XXh
01CAh	UART6 Transmit Buffer Register	U6TB	XXXXh
01CBh			
01CCh	UART6 Transmit/Receive Control Register 0	U6C0	0000 1000b
01CDh	UART6 Transmit/Receive Control Register 1	U6C1	XXXX 0010b
01CEh	UART6 Receive Buffer Register	U6RB	XXXXh
01CFh			
01D0h	UART5, UART6 Transmit/Receive Control Register	U56CON	X000 0000b
01D1h	UART5, UART6 Input Pin Function Select Register	U56IS	X000 X000b
01D2h			
01D3h			
01D4h			
01D5h			
01D6h			
01D7h			
01D8h	RTP Output Buffer Register 0	RTP0R	XXh
01D9h	RTP Output Buffer Register 1	RTP1R	XXh
01DAh	RTP Output Buffer Register 2	RTP2R	XXh
01DBh	RTP Output Buffer Register 3	RTP3R	XXh
01DCh			
01DDh			
01DEh			
01DFh			
01E0h	CAN0 Message Slot Buffer 0 Standard ID0 ⁽¹⁾⁽²⁾	C0SLOT0_0	XXh
01E1h	CAN0 Message Slot Buffer 0 Standard ID1 ⁽¹⁾⁽²⁾	C0SLOT0_1	XXh
01E2h	CAN0 Message Slot Buffer 0 Extended ID0 ⁽¹⁾⁽²⁾	C0SLOT0_2	XXh
01E3h	CAN0 Message Slot Buffer 0 Extended ID1 ⁽¹⁾⁽²⁾	C0SLOT0_3	XXh
01E4h	CAN0 Message Slot Buffer 0 Extended ID2 ⁽¹⁾⁽²⁾	C0SLOT0_4	XXh
01E5h	CAN0 Message Slot Buffer 0 Data Length Code ⁽¹⁾⁽²⁾	C0SLOT0_5	XXh
01E6h	CAN0 Message Slot Buffer 0 Data 0 ⁽¹⁾⁽²⁾	C0SLOT0_6	XXh
01E7h	CAN0 Message Slot Buffer 0 Data 1 ⁽¹⁾⁽²⁾	C0SLOT0_7	XXh
01E8h	CAN0 Message Slot Buffer 0 Data 2 ⁽¹⁾⁽²⁾	C0SLOT0_8	XXh
01E9h	CAN0 Message Slot Buffer 0 Data 3 ⁽¹⁾⁽²⁾	C0SLOT0_9	XXh
01EAh	CAN0 Message Slot Buffer 0 Data 4 ⁽¹⁾⁽²⁾	C0SLOT0_10	XXh
01EBh	CAN0 Message Slot Buffer 0 Data 5 ⁽¹⁾⁽²⁾	C0SLOT0_11	XXh
01ECh	CAN0 Message Slot Buffer 0 Data 6 ⁽¹⁾⁽²⁾	C0SLOT0_12	XXh
01EDh	CAN0 Message Slot Buffer 0 Data 7 ⁽¹⁾⁽²⁾	C0SLOT0_13	XXh
01EEh	CAN0 Message Slot Buffer 0 Time Stamp High-Order ⁽¹⁾⁽²⁾	C0SLOT0_14	XXh
01EFh	CAN0 Message Slot Buffer 0 Time Stamp Low-Order ⁽¹⁾⁽²⁾	C0SLOT0_15	XXh

X: Undefined

Blank spaces are all reserved. No access is allowed.

NOTES:

1. The CAN-associated registers (allocated in addresses 01E0h to 02BFh) cannot be used in M32C/87B. In M32C/87A, only CAN0-associated registers can be used.
2. Set the PM13 bit in the PM1 register to 1 (2 wait states for SFR area) before accessing the CAN-associated registers.

Table 4.9 SFR Address Map (9/20)

Address	Register ⁽²⁾⁽³⁾	Symbol	After Reset
01F0h	CAN0 Message Slot Buffer 1 Standard ID0	C0SLOT1_0	XXh
01F1h	CAN0 Message Slot Buffer 1 Standard ID1	C0SLOT1_1	XXh
01F2h	CAN0 Message Slot Buffer 1 Extended ID0	C0SLOT1_2	XXh
01F3h	CAN0 Message Slot Buffer 1 Extended ID1	C0SLOT1_3	XXh
01F4h	CAN0 Message Slot Buffer 1 Extended ID2	C0SLOT1_4	XXh
01F5h	CAN0 Message Slot Buffer 1 Data Length Code	C0SLOT1_5	XXh
01F6h	CAN0 Message Slot Buffer 1 Data 0	C0SLOT1_6	XXh
01F7h	CAN0 Message Slot Buffer 1 Data 1	C0SLOT1_7	XXh
01F8h	CAN0 Message Slot Buffer 1 Data 2	C0SLOT1_8	XXh
01F9h	CAN0 Message Slot Buffer 1 Data 3	C0SLOT1_9	XXh
01FAh	CAN0 Message Slot Buffer 1 Data 4	C0SLOT1_10	XXh
01FBh	CAN0 Message Slot Buffer 1 Data 5	C0SLOT1_11	XXh
01FCh	CAN0 Message Slot Buffer 1 Data 6	C0SLOT1_12	XXh
01FDh	CAN0 Message Slot Buffer 1 Data 7	C0SLOT1_13	XXh
01FEh	CAN0 Message Slot Buffer 1 Time Stamp High-Order	C0SLOT1_14	XXh
01FFh	CAN0 Message Slot Buffer 1 Time Stamp Low-Order	C0SLOT1_15	XXh
0200h	CAN0 Control Register 0	C0CLR0	XX01 0X01b ⁽¹⁾
0201h			XXXX 0000b ⁽¹⁾
0202h	CAN0 Status Register	C0STR	0000 0000b ⁽¹⁾
0203h			X000 0X01b ⁽¹⁾
0204h	CAN0 Extended ID Register	C0IDR	0000h ⁽¹⁾
0205h			
0206h	CAN0 Configuration Register	C0CONR	0000 XXXXb ⁽¹⁾
0207h			0000 0000b ⁽¹⁾
0208h	CAN0 Time Stamp Register	C0TSR	0000h ⁽¹⁾
0209h			
020Ah	CAN0 Transmit Error Count Register	C0TEC	00h ⁽¹⁾
020Bh	CAN0 Receive Error Count Register	C0REC	00h ⁽¹⁾
020Ch	CAN0 Slot Interrupt Status Register	C0SISTR	0000h ⁽¹⁾
020Dh			
020Eh			
020Fh			
0210h	CAN0 Slot Interrupt Mask Register	C0SIMKR	0000h ⁽¹⁾
0211h			
0212h			
0213h			
0214h	CAN0 Error Interrupt Mask Register	C0EIMKR	XXXX X000b ⁽¹⁾
0215h	CAN0 Error Interrupt Status Register	C0EISTR	XXXX X000b ⁽¹⁾
0216h	CAN0 Error Source Register	C0EFR	00h ⁽¹⁾
0217h	CAN0 Baud Rate Prescaler	C0BRP	0000 0001b ⁽¹⁾
0218h			
0219h	CAN0 Mode Register	C0MDR	XXXX XX00b ⁽¹⁾
021Ah			
021Bh			
021Ch			
021Dh			
021Eh			
021Fh			

X: Undefined

Blank spaces are all reserved. No access is allowed.

NOTES:

- Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and supplying a clock to the CAN module.
- The CAN-associated registers (allocated in addresses 01E0h to 02BFh) cannot be used in M32C/87B. In M32C/87A, only CAN0-associated registers can be used.
- Set the PM13 bit in the PM1 register to 1 (2 wait states for SFR area) before accessing the CAN-associated registers.

Table 4.10 SFR Address Map (10/20)

Address	Register ⁽³⁾⁽⁴⁾	Symbol	After Reset
0220h	CAN0 Single Shot Control Register	C0SCTLR	0000h ⁽¹⁾⁽²⁾
0221h			
0222h			
0223h			
0224h	CAN0 Single Shot Status Register	C0SSSTR	0000h ⁽¹⁾⁽²⁾
0225h			
0226h			
0227h			
0228h	CAN0 Global Mask Register Standard ID0	C0GMR0	XXX0 0000b ⁽¹⁾⁽²⁾
0229h	CAN0 Global Mask Register Standard ID1	C0GMR1	XX00 0000b ⁽¹⁾⁽²⁾
022Ah	CAN0 Global Mask Register Extended ID0	C0GMR2	XXXX 0000b ⁽¹⁾⁽²⁾
022Bh	CAN0 Global Mask Register Extended ID1	C0GMR3	00h ⁽¹⁾⁽²⁾
022Ch	CAN0 Global Mask Register Extended ID2	C0GMR4	XX00 0000b ⁽¹⁾⁽²⁾
022Dh			
022Eh			
022Fh			
0230h	CAN0 Message Slot 0 Control Register / CAN0 Local Mask Register A Standard ID0	C0MCTL0 / C0LMAR0	0000 0000b ⁽¹⁾⁽²⁾ / XXX0 0000b ⁽¹⁾⁽²⁾
0231h	CAN0 Message Slot 1 Control Register / CAN0 Local Mask Register A Standard ID1	C0MCTL1 / C0LMAR1	0000 0000b ⁽¹⁾⁽²⁾ / XX00 0000b ⁽¹⁾⁽²⁾
0232h	CAN0 Message Slot 2 Control Register / CAN0 Local Mask Register A Extended ID0	C0MCTL2 / C0LMAR2	0000 0000b ⁽¹⁾⁽²⁾ / XXXX 0000b ⁽¹⁾⁽²⁾
0233h	CAN0 Message Slot 3 Control Register / CAN0 Local Mask Register A Extended ID1	C0MCTL3 / C0LMAR3	00h ⁽¹⁾⁽²⁾ / 00h ⁽¹⁾⁽²⁾
0234h	CAN0 Message Slot 4 Control Register / CAN0 Local Mask Register A Extended ID2	C0MCTL4 / C0LMAR4	0000 0000b ⁽¹⁾⁽²⁾ / XX00 0000b ⁽¹⁾⁽²⁾
0235h	CAN0 Message Slot 5 Control Register	C0MCTL5	00h ⁽¹⁾⁽²⁾
0236h	CAN0 Message Slot 6 Control Register	C0MCTL6	00h ⁽¹⁾⁽²⁾
0237h	CAN0 Message Slot 7 Control Register	C0MCTL7	00h ⁽¹⁾⁽²⁾
0238h	CAN0 Message Slot 8 Control Register / CAN0 Local Mask Register B Standard ID0	C0MCTL8 / C0LMAR0	0000 0000b ⁽¹⁾⁽²⁾ / XXX0 0000b ⁽¹⁾⁽²⁾
0239h	CAN0 Message Slot 9 Control Register / CAN0 Local Mask Register B Standard ID1	C0MCTL9 / C0LMAR1	0000 0000b ⁽¹⁾⁽²⁾ / XX00 0000b ⁽¹⁾⁽²⁾
023Ah	CAN0 Message Slot 10 Control Register / CAN0 Local Mask Register B Extended ID0	C0MCTL10 / C0LMAR2	0000 0000b ⁽¹⁾⁽²⁾ / XXXX 0000b ⁽¹⁾⁽²⁾
023Bh	CAN0 Message Slot 11 Control Register / CAN0 Local Mask Register B Extended ID1	C0MCTL11 / C0LMAR3	00h ⁽¹⁾⁽²⁾ / 00h ⁽¹⁾⁽²⁾
023Ch	CAN0 Message Slot 12 Control Register / CAN0 Local Mask Register B Extended ID2	C0MCTL12 / C0LMAR4	0000 0000b ⁽¹⁾⁽²⁾ / XX00 0000b ⁽¹⁾⁽²⁾
023Dh	CAN0 Message Slot 13 Control Register	C0MCTL13	00h ⁽¹⁾⁽²⁾
023Eh	CAN0 Message Slot 14 Control Register	C0MCTL14	00h ⁽¹⁾⁽²⁾
023Fh	CAN0 Message Slot 15 Control Register	C0MCTL15	00h ⁽¹⁾⁽²⁾
0240h	CAN0 Slot Buffer Select Register	C0SBS	00h ⁽²⁾
0241h	CAN0 Control Register 1	C0CTLR1	X000 00XXb ⁽²⁾
0242h	CAN0 Sleep Control Register	C0SLPR	XXXX XXX0b
0243h			
0244h	CAN0 Acceptance Filter Support Register	C0AFS	0000 0000b ⁽²⁾ 0000 0001b ⁽²⁾
0245h			
0246h			
0247h			
0248h			
0249h			
024Ah to 024Fh			

X: Undefined

Blank spaces are all reserved. No access is allowed.

NOTES:

1. The BANKSEL bit in the C0CTLR1 register can switch functions for addresses 0220h to 023Fh.
2. Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and supplying a clock to the CAN module.
3. The CAN-associated registers (allocated in addresses 01E0h to 02BFh) cannot be used in M32C/87B. In M32C/87A, only CAN0-associated registers can be used.
4. Set the PM13 bit in the PM1 register to 1 (2 wait states for SFR area) before accessing the CAN-associated registers.

Table 4.12 SFR Address Map (12/20)

Address	Register ⁽³⁾ (4)	Symbol	After Reset
0280h	CAN1 Control Register 0	C1CTLR0	XX01 0X01b ⁽²⁾
0281h			XXXX 0000b ⁽²⁾
0282h	CAN1 Status Register	C1STR	0000 0000b ⁽²⁾
0283h			X000 0X01b ⁽²⁾
0284h	CAN1 Extended ID Register	C1IDR	0000h ⁽²⁾
0285h			
0286h	CAN1 Configuration Register	C1CONR	0000 XXXXb ⁽²⁾
0287h			0000 0000b ⁽²⁾
0288h	CAN1 Time Stamp Register	C1TSR	0000h ⁽²⁾
0289h			
028Ah	CAN1 Transmit Error Count Register	C1TEC	00h ⁽²⁾
028Bh	CAN1 Receive Error Count Register	C1REC	00h ⁽²⁾
028Ch	CAN1 Slot Interrupt Status Register	C1SISTR	0000h ⁽²⁾
028Dh			
028Eh			
028Fh			
0290h	CAN1 Slot Interrupt Mask Register	C1SIMKR	0000h ⁽²⁾
0291h			
0292h			
0293h			
0294h	CAN1 Error Interrupt Mask Register	C1EIMKR	XXXX X000b ⁽²⁾
0295h	CAN1 Error Interrupt Status Register	C1EISTR	XXXX X000b ⁽²⁾
0296h	CAN1 Error Source Register	C1EFR	00h ⁽²⁾
0297h	CAN1 Baud Rate Prescaler	C1BRP	0000 0001b ⁽²⁾
0298h			
0299h	CAN1 Mode Register	C1MDR	XXXX XX00b ⁽²⁾
029Ah			
029Bh			
029Ch			
029Dh			
029Eh			
029Fh			
02A0h	CAN1 Single Shot Control Register	C1SSCTLR	0000h ⁽¹⁾⁽²⁾
02A1h			
02A2h			
02A3h			
02A4h	CAN1 Single Shot Status Register	C1SSSTR	0000h ⁽¹⁾⁽²⁾
02A5h			
02A6h			
02A7h			
02A8h	CAN1 Global Mask Register Standard ID0	C1GMR0	XXX0 0000b ⁽¹⁾⁽²⁾
02A9h	CAN1 Global Mask Register Standard ID1	C1GMR1	XX00 0000b ⁽¹⁾⁽²⁾
02AAh	CAN1 Global Mask Register Extended ID0	C1GMR2	XXXX 0000b ⁽¹⁾⁽²⁾
02ABh	CAN1 Global Mask Register Extended ID1	C1GMR3	00h ⁽¹⁾⁽²⁾
02ACh	CAN1 Global Mask Register Extended ID2	C1GMR4	XX00 0000b ⁽¹⁾⁽²⁾
02ADh			
02AEh			
02AFh			

X: Undefined

Blank spaces are all reserved. No access is allowed.

NOTES:

1. The BANKSEL bit in the C0CTLR1 register can switch functions for addresses 02A0h to 02BFh.
2. Values are obtained by setting the SLEEP bit in the C1SLPR register to "1" (sleep mode exited) after reset and supplying a clock to the CAN module.
3. The CAN-associated registers (allocated in addresses 01E0h to 02BFh) cannot be used in M32C/87B. In M32C/87A, only CAN0-associated registers can be used.
4. Set the PM13 bit in the PM1 register to 1 (2 wait states for SFR area) before accessing the CAN-associated registers.

Table 4.17 SFR Address Map (17/20)

Address	Register	Symbol	After Reset
0350h	Timer B0 Register	TB0	XXXXh
0351h			
0352h	Timer B1 Register	TB1	XXXXh
0353h			
0354h	Timer B2 Register	TB2	XXXXh
0355h			
0356h	Timer A0 Mode Register	TA0MR	00h
0357h	Timer A1 Mode Register	TA1MR	00h
0358h	Timer A2 Mode Register	TA2MR	00h
0359h	Timer A3 Mode Register	TA3MR	00h
035Ah	Timer A4 Mode Register	TA4MR	00h
035Bh	Timer B0 Mode Register	TB0MR	00XX 0000b
035Ch	Timer B1 Mode Register	TB1MR	00XX 0000b
035Dh	Timer B2 Mode Register	TB2MR	00XX 0000b
035Eh	Timer B2 Special Mode Register	TB2SC	XXXX XXX0b
035Fh	Count Source Prescaler Register ⁽¹⁾	TCSPR	0XXX 0000b
0360h			
0361h			
0362h			
0363h			
0364h	UART0 Special Mode Register 4	U0SMR4	00h
0365h	UART0 Special Mode Register 3	U0SMR3	00h
0366h	UART0 Special Mode Register 2	U0SMR2	00h
0367h	UART0 Special Mode Register	U0SMR	00h
0368h	UART0 Transmit/Receive Mode Register	U0MR	00h
0369h	UART0 Baud Rate Register	U0BRG	XXh
036Ah	UART0 Transmit Buffer Register	U0TB	XXXXh
036Bh			
036Ch	UART0 Transmit/Receive Control Register 0	U0C0	0000 1000b
036Dh	UART0 Transmit/Receive Control Register 1	U0C1	0000 0010b
036Eh	UART0 Receive Buffer Register	U0RB	XXXXh
036Fh			
0370h			
0371h			
0372h	IrDA Control Register	IRCON	X000 0000b
0373h			
0374h			
0375h			
0376h			
0377h			
0378h	DMA0 Request Source Select Register	DM0SL	0X00 0000b
0379h	DMA1 Request Source Select Register	DM1SL	0X00 0000b
037Ah	DMA2 Request Source Select Register	DM2SL	0X00 0000b
037Bh	DMA3 Request Source Select Register	DM3SL	0X00 0000b
037Ch	CRC Data Register	CRCD	XXXXh
037Dh			
037Eh	CRC Input Register	CRCIN	XXh
037Fh			

X: Undefined

Blank spaces are all reserved. No access is allowed.

NOTE:

1. The TCSPR register maintains values set before reset, even after software reset or watchdog timer reset has been performed.

Table 4.20 SFR Address Map (20/20)

Address	Register	Symbol	After Reset
03D0h	Port P14 Register ⁽¹⁾	P14	XXh
03D1h	Port P15 Register ⁽¹⁾	P15	XXh
03D2h	Port P14 Direction Register ⁽¹⁾⁽²⁾	PD14	X000 0000b
03D3h	Port P15 Direction Register ⁽¹⁾⁽²⁾	PD15	00h
03D4h			
03D5h			
03D6h			
03D7h			
03D8h			
03D9h			
03DAh	Pull-Up Control Register 2	PUR2	00h
03DBh	Pull-Up Control Register 3	PUR3	00h
03DCh	Pull-Up Control Register 4 ⁽¹⁾⁽³⁾	PUR4	XXXX 0000b
03DDh			
03DEh			
03DFh			
03E0h	Port P0 Register	P0	XXh
03E1h	Port P1 Register	P1	XXh
03E2h	Port P0 Direction Register	PD0	00h
03E3h	Port P1 Direction Register	PD1	00h
03E4h	Port P2 Register	P2	XXh
03E5h	Port P3 Register	P3	XXh
03E6h	Port P2 Direction Register	PD2	00h
03E7h	Port P3 Direction Register	PD3	00h
03E8h	Port P4 Register	P4	XXh
03E9h	Port P5 Register	P5	XXh
03EAh	Port P4 Direction Register	PD4	00h
03EBh	Port P5 Direction Register	PD5	00h
03ECh			
03EDh			
03EEh			
03EFh			
03F0h	Pull-Up Control Register 0	PUR0	00h
03F1h	Pull-Up Control Register 1	PUR1	XXXX 0000b
03F2h			
03F3h			
03F4h			
03F5h			
03F6h			
03F7h			
03F8h			
03F9h			
03FAh			
03FBh			
03FCh			
03FDh			
03FEh			
03FFh	Port Control Register	PCR	XXXX X000b

X: Undefined

Blank spaces are all reserved. No access is allowed.

NOTES:

1. These registers cannot be used in the 100-pin package.
2. Set to FFh in the 100-pin package.
3. Set to 00h in the 100-pin package.

$$VCC1 = VCC2 = 5V$$

Timing Requirements

(VCC1 = VCC2 = 4.2 to 5.5 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.23 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(AD)	ADTRG input cycle time (required for trigger)	1000		ns
tw(ADL)	ADTRG input low ("L") pulse width	125		ns

Table 5.24 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input high ("H") pulse width	100		ns
tw(CKL)	CLKi input low ("L") pulse width	100		ns
td(C-Q)	TXDi output delay time		80	ns
th(C-Q)	TXDi output hold time	0		ns
tsu(D-C)	RXDi input setup time	70		ns
th(C-D)	RXDi input hold time	90		ns

i = 0 to 6

Table 5.25 Intelligent I/O Communication Function (Groups 0 and 1)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(CK)	ISCLKi input cycle time	600		ns
tw(CKH)	ISCLKi input high ("H") pulse width	300		ns
tw(CKL)	ISCLKi input low ("L") pulse width	300		ns
td(C-Q)	ISTXDi output delay time		100	ns
th(C-Q)	ISTXDi output hold time	0		ns
tsu(D-C)	ISRXDi input setup time	100		ns
th(C-D)	ISRXDi input hold time	100		ns

i = 0, 1

Table 5.26 Intelligent I/O Communication Function (Group 2)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc(CK)	ISCLK2 input cycle time	600		ns
tw(CKH)	ISCLK2 input high ("H") pulse width	300		ns
tw(CKL)	ISCLK2 input low ("L") pulse width	300		ns
td(C-Q)	ISTXD2 output delay time		180	ns
th(C-Q)	ISTXD2 output hold time	0		ns
tsu(D-C)	ISRXD2 input setup time	150		ns
th(C-D)	ISRXD2 input hold time	100		ns

$$VCC1 = VCC2 = 5V$$

Timing Requirements

(VCC1 = VCC2 = 4.2 to 5.5 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.28 Memory Expansion mode and Microprocessor Mode

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tac1(RD-DB)	Data input access time (RD standard)		(note 1)	ns
tac1(AD-DB)	Data input access time (AD standard, CS standard)		(note 1)	ns
tac2(RD-DB)	Data input access time (RD standard, when accessing a space with the multiplexed bus)		(note 1)	ns
tac2(AD-DB)	Data input access time (AD standard, when accessing a space with the multiplexed bus)		(note 1)	ns
tsu(DB-BCLK)	Data input setup time	26		ns
tsu(RDY-BCLK)	$\overline{RDY}$ input setup time	26		ns
tsu(HOLD-BCLK)	$\overline{HOLD}$ input setup time	30		ns
th(RD-DB)	Data input hold time	0		ns
th(BCLK-RDY)	$\overline{RDY}$ input hold time	0		ns
th(BCLK-HOLD)	$\overline{HOLD}$ input hold time	0		ns
td(BCLK-HLDA)	HLDA output delay time		25	ns

NOTE:

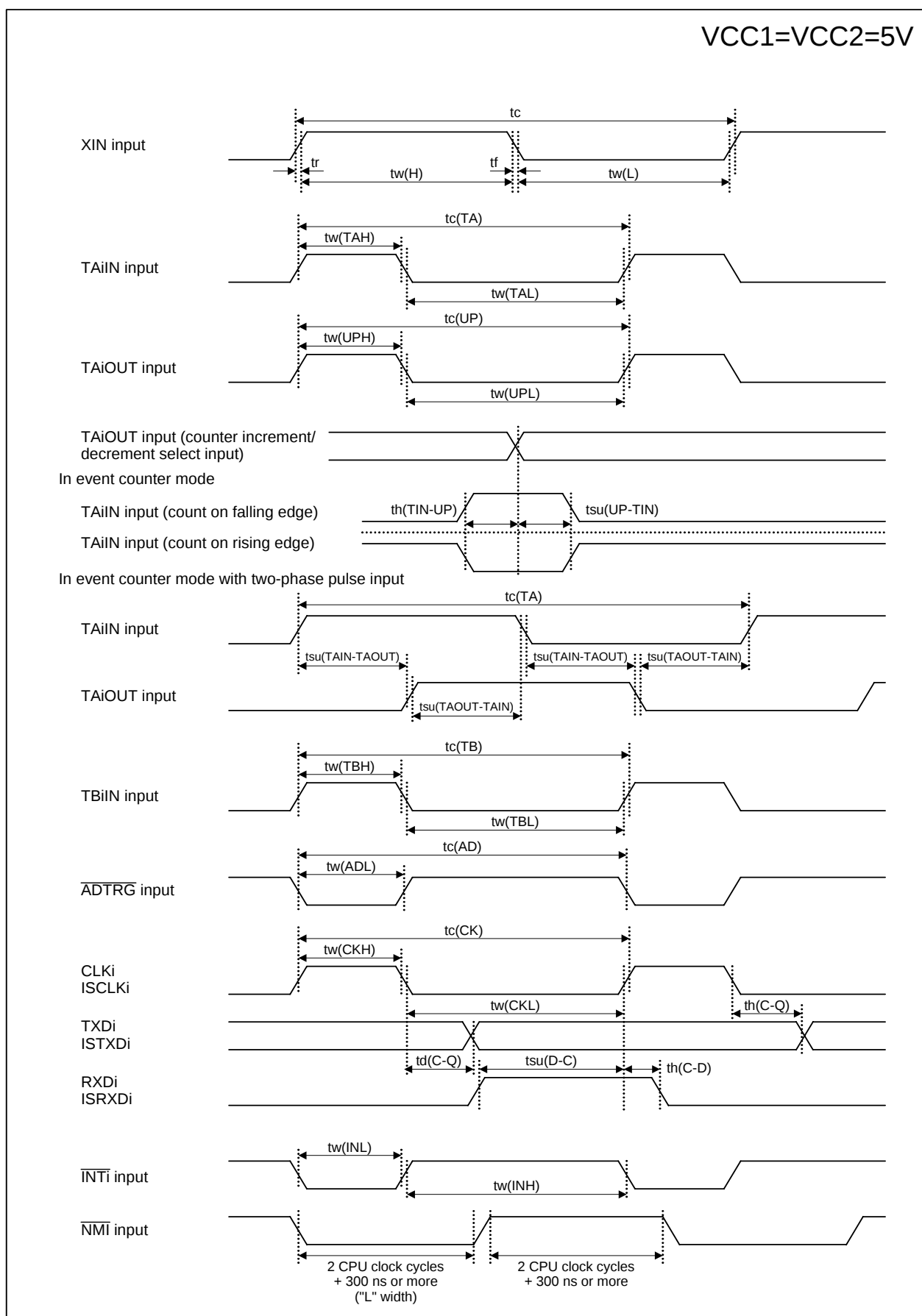
- Values, which depend on BCLK frequency and external bus cycles, can be obtained from the following equations. Insert wait states or lower the operation frequency, f(BCLK), if the calculated value is negative.

$$tac1(RD-DB) = \frac{10^9 \times m}{f(BCLK) \times 2} - 35 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, m = (b \times 2) + 1)$$

$$tac1(AD-DB) = \frac{10^9 \times n}{f(BCLK)} - 35 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, n = a + b)$$

$$tac2(RD-DB) = \frac{10^9 \times m}{f(BCLK) \times 2} - 35 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, m = (b \times 2) - 1)$$

$$tac2(AD-DB) = \frac{10^9 \times p}{f(BCLK) \times 2} - 35 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, p = \{(a + b - 1) \times 2\} + 1)$$

**Figure 5.3 VCC1 = VCC2 = 5 V Timing Diagram (1/4)**

$$VCC1 = VCC2 = 3.3 \text{ V}$$

Table 5.33 Electrical Characteristics (3/3)
(VCC1 = VCC2 = 3.3 V, VSS = 0 V, Topr = 25°C)

Symbol	Parameter	Measurement Condition ⁽¹⁾	Standard			Unit
			Min.	Typ.	Max.	
ICC	Power supply current	Flash memory version	f(CPU) = 24 MHz	23	33	mA
			f(CPU) = 16 MHz	17		mA
			f(CPU) = 8 MHz	11		mA
			f(CPU) = f(Ring) In on-chip oscillator low-power consumption mode	2.6		mA
			f(CPU) = 32 kHz In low-power consumption mode While flash memory is operating	430		μA
			f(CPU) = 32 kHz In low-power consumption mode While flash memory is stopped ⁽²⁾	30		μA
			Wait mode: f(CPU) = f(Ring) After entering wait mode from on-chip oscillator low-power consumption mode	45		μA
			Stop mode (while clock is stopped)	0.8	5	μA
			Stop mode (while clock is stopped) Topr = 85°C		50	μA
		Mask ROM version	f(CPU) = 24 MHz	23	33	mA
			f(CPU) = 16 MHz	17		mA
			f(CPU) = 8 MHz	11		mA
			f(CPU) = f(Ring) In on-chip oscillator low-power consumption mode	1		mA
			f(CPU) = 32 kHz In low-power consumption mode	30		μA
			Wait mode: f(CPU) = f(Ring) After entering wait mode from on-chip oscillator low-power consumption mode	45		μA
			Stop mode (while clock is stopped)	0.8	5	μA
			Stop mode (while clock is stopped) Topr = 85°C		50	μA

NOTES:

1. In single-chip mode, leave the output pins open and connect the input pins to VSS.
2. Value is obtained when setting the FMSTP bit in the FMR0 register to 1 (flash memory stopped) and running the program on RAM.

$$VCC1 = VCC2 = 3.3 \text{ V}$$

Switching Characteristics

(VCC1 = VCC2 = 3.0 to 3.6 V, VSS = 0 V, Topr = -20 to 85°C unless otherwise specified)

Table 5.53 Memory Expansion Mode and Microprocessor Mode (when accessing external memory space with multiplexed bus)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
td(BCLK-AD)	Address output delay time	See Figure 5.2		18	ns
th(BCLK-AD)	Address output hold time (BCLK standard)		-3		ns
th(RD-AD)	Address output hold time (RD standard) ⁽⁵⁾		(note 1)		ns
th(WR-AD)	Address output hold time (WR standard) ⁽⁵⁾		(note 1)		ns
td(BCLK-CS)	Chip-select signal output delay time			18	ns
th(BCLK-CS)	Chip-select signal output hold time (BCLK standard)		-3		ns
th(RD-CS)	Chip-select signal output hold time (RD standard) ⁽⁵⁾		(note 1)		ns
th(WR-CS)	Chip-select signal output hold time (WR standard) ⁽⁵⁾		(note 1)		ns
td(BCLK-RD)	RD signal output delay time			18	ns
th(BCLK-RD)	RD signal output hold time		-5		ns
td(BCLK-WR)	WR signal output delay time			18	ns
th(BCLK-WR)	WR signal output hold time		0		ns
td(DB-WR)	Data output delay time (WR standard)		(note 2)		ns
th(WR-DB)	Data output hold time (WR standard) ⁽⁵⁾		(note 1)		ns
td(BCLK-ALE)	ALE signal output delay time (BCLK standard)			18	ns
th(BCLK-ALE)	ALE signal output hold time (BCLK standard)		-2		ns
td(AD-ALE)	ALE signal output delay time (address standard)		(note 3)		ns
th(ALE-AD)	ALE signal output hold time (address standard)		(note 4)		ns
tdz(RD-AD)	Address output float start time			8	ns

NOTES:

1. Values, which depend on BCLK frequency, can be obtained from the following equations.

$$th(RD-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \text{ [ns]}$$

$$th(WR-AD) = \frac{10^9}{f(BCLK) \times 2} - 15 \text{ [ns]}$$

$$th(RD-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \text{ [ns]}$$

$$th(WR-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \text{ [ns]}$$

$$th(WR-DB) = \frac{10^9}{f(BCLK) \times 2} - 20 \text{ [ns]}$$

2. Values, which depend on BCLK frequency and external bus cycles, can be obtained from the following equation.

$$td(DB-WR) = \frac{10^9 \times m}{f(BCLK) \times 2} - 25 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, m = (b \times 2) - 1)$$

3. Values, which depend on BCLK frequency and external bus cycles, can be obtained from the following equation.

$$td(AD-ALE) = \frac{10^9 \times n}{f(BCLK) \times 2} - 20 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, n = a)$$

4. Values, which depend on BCLK frequency and external bus cycles, can be obtained from the following equation.

$$th(ALE-AD) = \frac{10^9 \times n}{f(BCLK) \times 2} - 20 \text{ [ns]} \text{ (if external bus cycle is } a\phi + b\phi, n = a)$$

5. tc [ns] is added when recovery cycle is inserted.

REVISION HISTORY		M32C/87 Group Datasheet	
Rev.	Date	Description	
		Page	Summary
		42	SFR • [Register names changed] 0342h One-Shot Start Flag → One-Shot Start Register 0344h Up-Down Flag → Up/Down Select Register • [Value After Reset changed] 27 000Fh WDC 000X XXX2 → 00XX XXXXb 27 002Fh D4INT 0016 → XX00 0000b 29 007Bh IIO6IC XX00 X0002 → XXXX X000b 31 00EFh G0CR XX00 X0112 → 0000 X011b 31 00FEh G0IRF 0016 → 0000 XXXXb 32 013Eh G1IRF 0016 → 0000 XXXXb 34 01C7h to 01C6h U5RB XXXX XXXX XXXX 0XXX2 → XXXXh 34 01CFh to 01CEh U6RB XXXX XXXX XXXX 0XXX2 → XXXXh 44 038Fh to 0382h AD07 to AD01 XXXX16 → 00XXh
		47	Electrical Characteristics • [Term changed] Low Voltage Reset → Hardware Reset 2 Low Voltage Detection → Vdet3 and Vdet4 detection circuit • Table 5.1 Description in Condition field of Pd (Power consumption) partially modified • Tables 5.2 to 5.9 f(BCLK) is changed to f(CPU) • Table 5.4 Description added in Parameter field of f(CPU); f(VCO) added • Tables 5.5 to 5.7 and Tables 5.31 to 5.33 Description in XCOUT and Hysteresis in Parameter fields partially modified • Table 5.7 and 5.33 Structure and standard values revised; items in Measurement Condition and NOTE added • Table 5.8 Description in Parameter field and NOTE partially modified • Table 5.9 and 5.10 Description in Parameter field and NOTE partially modified • Tables 5.11 and 5.36 Description in Parameter field and standard value partially modified • Tables 5.19 and 5.42 added • Table 5.24 Values revised; Table 5.25 and 5.26 added • Table 5.27 Titles modified; NOTE added • Table 5.28 moved to the last table in Timing Requirements • Table 5.29 NOTE 3 added; Table 26.30 NOTE 5 added • Figures 5.3 to 5.6 Order rearranged; measurement condition modified • Table 5.31 to 5.35 f(BCLK) revised to f(CPU) • Table 5.47 Values revised; Table 5.48 and 5.49 added • Table 5.50 Titles modified; NOTE added • Table 5.51 Table moved to the last table in Timing Requirements • Table 5.52 NOTE 3 added; Table 5.53 NOTE 5 added • Figures 5.7 to 5.10 Order rearranged
1.51	Jul 31, 2008	–	All in this manual [description modified] • Title of group tables “(current table number / total tables)” added
		19 21	Overview • 1.5 Pin Descriptions Chapter and table title changed to Pin Functions • Table 1.17 Supply voltage for AN0_0 to AN0_7, AN2_0 to AN2_7 modified

REVISION HISTORY		M32C/87 Group Datasheet	
Rev.	Date	Description	
		Page	Summary
		46	Special Function Registers (SFRs) • Table 4.20 A value of After Reset column in 03FFh modified

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